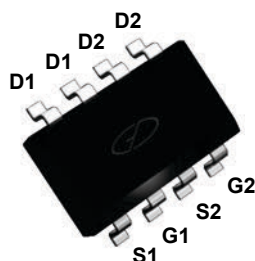
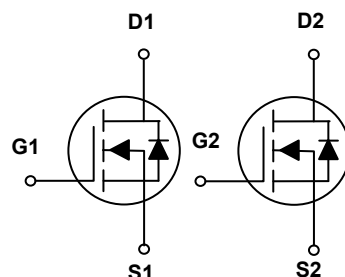


**Main Product Characteristics**

$V_{(BR)DSS}$	40V
$R_{DS(ON)}$	15mΩ
$I_D$	10A



SOP-8



Schematic Diagram

**Features and Benefits**

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



**Description**

The GSFQ4856 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

**Absolute Maximum Ratings** ( $T_C=25^{\circ}C$  unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	±20	V
Drain Current – Continuous ( $T_C=25^{\circ}C$ )	$I_D$	10	A
Drain Current – Continuous ( $T_C=100^{\circ}C$ )		6.3	A
Drain Current – Pulsed <sup>1</sup>	$I_{DM}$	40	A
Single Pulse Avalanche Energy <sup>2</sup>	$E_{AS}$	76	mJ
Single Pulse Avalanche Current <sup>2</sup>	$I_{AS}$	39	A
Power Dissipation ( $T_C=25^{\circ}C$ )	$P_D$	2.1	W
Power Dissipation – Derate above 25°C		0.017	W/°C
Storage Temperature Range	$T_{STG}$	-50 to +150	°C
Operating Junction Temperature Range	$T_J$	-50 to +150	°C

**Thermal Characteristics**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	---	60	°C/W

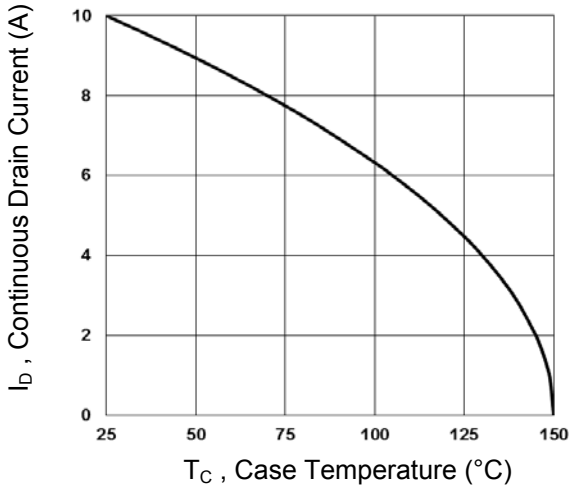
**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	40	---	---	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=40V, V_{GS}=0V, T_J=25^{\circ}\text{C}$	---	---	1	$\mu A$
		$V_{DS}=32V, V_{GS}=0V, T_J=125^{\circ}\text{C}$	---	---	10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=8A$	---	12	15	m $\Omega$
		$V_{GS}=4.5V, I_D=6A$	---	15	20	m $\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.8	2.5	V
Forward Transconductance	$g_{fs}$	$V_{DS}=10V, I_D=1A$	---	5	---	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3, 4</sup>	$Q_g$	$V_{DS}=20V, V_{GS}=4.5V, I_D=10A$	---	13	26	nC
Gate-Source Charge <sup>3, 4</sup>	$Q_{gs}$		---	4	8	
Gate-Drain Charge <sup>3, 4</sup>	$Q_{gd}$		---	5.3	10	
Turn-On Delay Time <sup>3, 4</sup>	$T_{d(on)}$	$V_{DD}=20V, V_{GS}=10V, R_G=6\Omega, I_D=1A$	---	8	16	nS
Rise Time <sup>3, 4</sup>	$T_r$		---	3.2	8	
Turn-Off Delay Time <sup>3, 4</sup>	$T_{d(off)}$		---	26.4	52	
Fall Time <sup>3, 4</sup>	$T_f$		---	3.8	8	
Input Capacitance	$C_{iss}$	$V_{DS}=20V, V_{GS}=0V, F=1\text{MHz}$	---	1088	2000	pF
Output Capacitance	$C_{oss}$		---	110	200	
Reverse Transfer Capacitance	$C_{rss}$		---	80	160	
Gate Resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	3	6	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_S$	$V_{GS}=V_D=0V, \text{Force Current}$	---	---	10	A
Pulsed Source Current	$I_{SM}$		---	---	20	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=1A, T_J=25^{\circ}\text{C}$	---	---	1	V

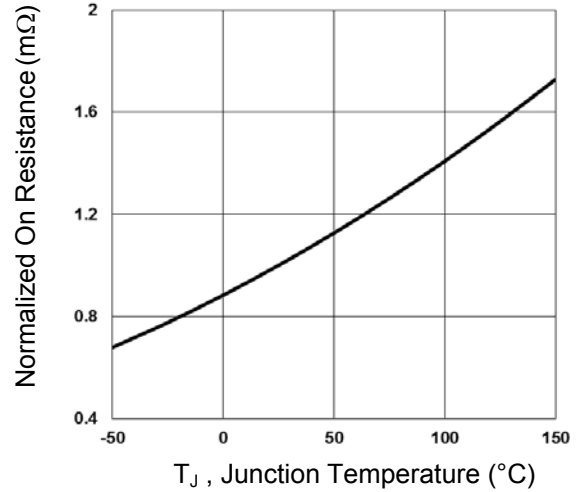
Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=39A, R_G=25\Omega, \text{Starting } T_J=25^{\circ}\text{C}.$
3. The data tested by pulsed, pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

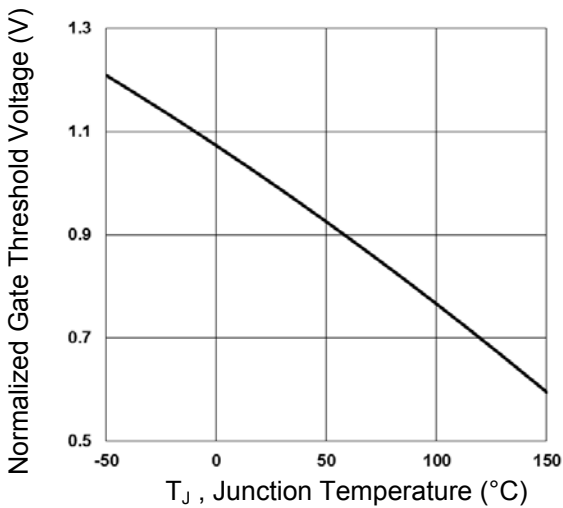
**Typical Electrical and Thermal Characteristic Curves**



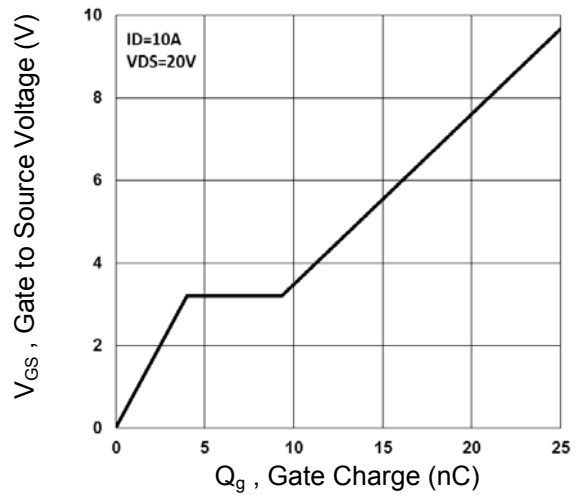
**Fig.1 Continuous Drain Current vs.  $T_C$**



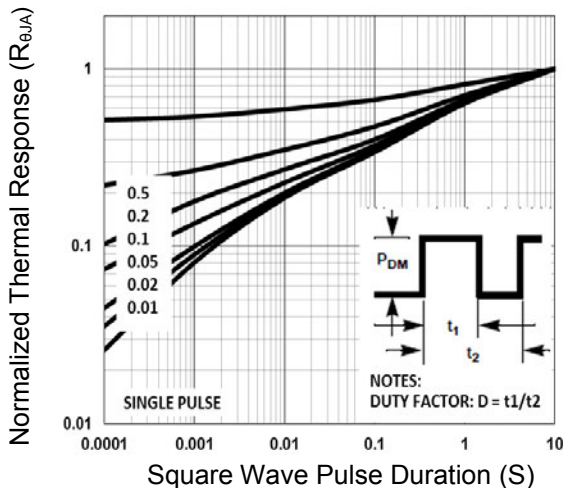
**Fig.2 Normalized  $R_{DS(ON)}$  vs.  $T_J$**



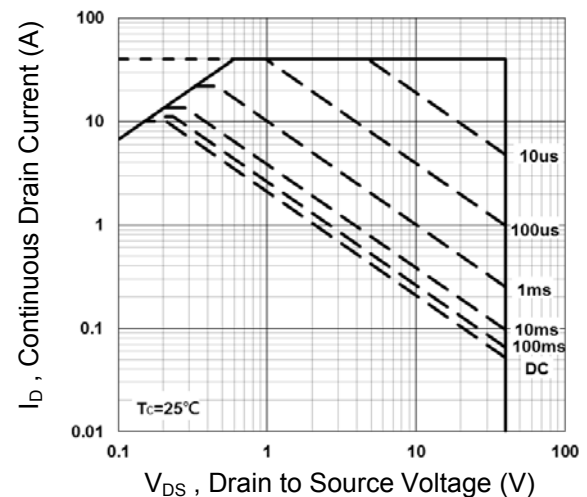
**Fig.3 Normalized  $V_{th}$  vs.  $T_J$**



**Fig.4 Gate Charge Waveform**

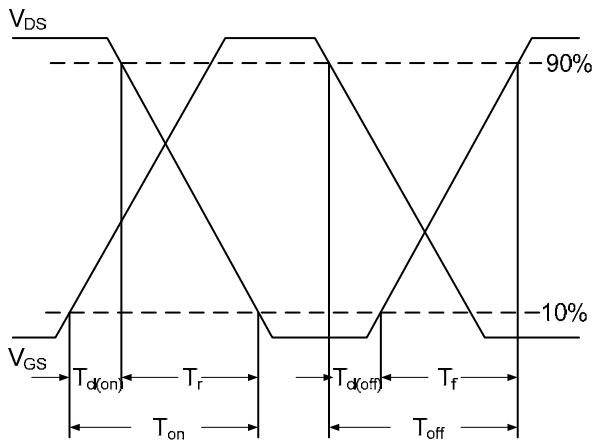


**Fig.5 Normalized Transient Impedance**

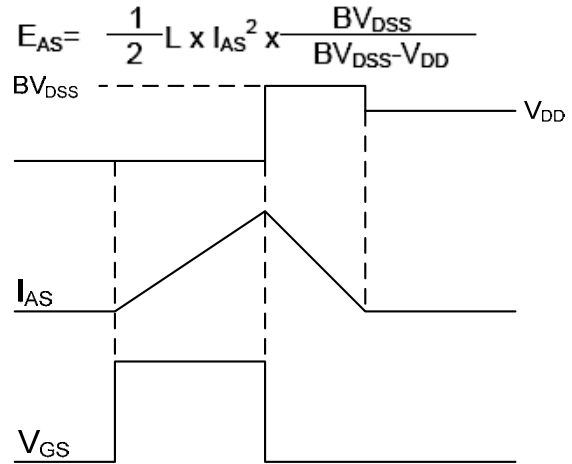


**Fig.6 Maximum Safe Operation Area**

**Typical Electrical and Thermal Characteristic Curves**



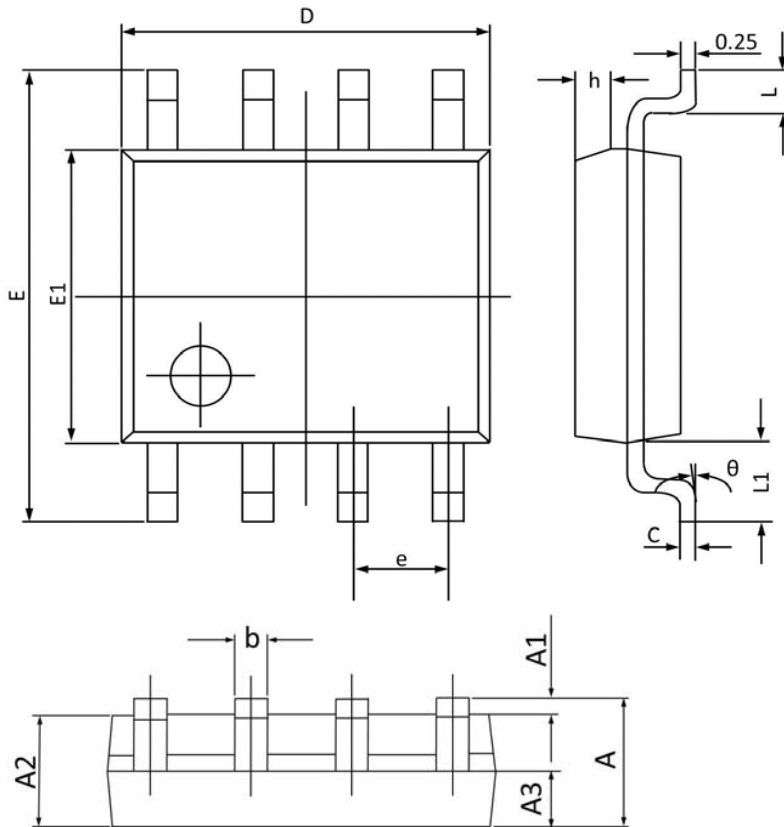
**Fig.7 Switching Time Waveform**



**Fig.8  $E_{AS}$  Waveform**

**Package Outline Dimensions**

**SOP-8**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.068
A1	0.1	0.25	0.004	0.009
A2	1.3	1.5	0.052	0.059
A3	0.6	0.7	0.024	0.027
b	0.39	0.48	0.016	0.018
c	0.21	0.26	0.009	0.01
D	4.7	5.1	0.186	0.2
E	5.8	6.2	0.229	0.244
E1	3.7	4.1	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.25	0.5	0.01	0.019
L	0.5	0.8	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
θ	0°	8°	0°	8°